

(12) UK Patent Application (19) GB (11) 2 340 831 (13) A

(43) Date of A Publication 01.03.2000

(21) Application No 9920124.6

(22) Date of Filing 26.08.1999

(30) Priority Data

(31) 98034694 (32) 26.08.1998 (33) KR
(31) 98039079 (32) 21.09.1998

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(51) INT CL⁷

C07D 493/08 , C07C 69/753 , C08F 224/00 232/08

(52) UK CL (Edition R)

C2C CAA CBC CBM C1200 C1480 C200 C213 C214
C22X C22Y C227 C233 C237 C240 C247 C25Y C253
C30Y C305 C36Y C360 C361 C364 C366 C367 C368
C43X C490 C491 C623 C624 C638 C65X C652 C668
C678 C815
C3P PDG PDL
U1S S1542 S3018

(56) Documents Cited

None

(58) Field of Search

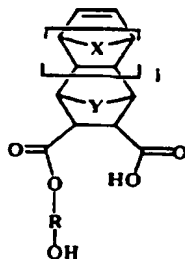
UK CL (Edition Q) C2C CBC CBM
ONLINE:CAS-ONLINE

(54) Abstract Title

Photoresist monomer having hydroxy group and carboxy group, copolymer thereof and photoresist composition using the same

(57) The present invention relates to novel monomers which can be used to form polymers which are useful in a photolithography employing a light source in the far ultraviolet region of the light spectrum, copolymers thereof, and photoresist compositions prepared therefrom. Photoresist monomers of the present invention are represented by the following Chemical Formula 1:

<Chemical Formula 1>



wherein,

R is substituted or non-substituted linear or branched (C₁-C₁₀) alkyl, substituted or non-substituted (C₁-C₁₀) ether, substituted or non-substituted (C₁-C₁₀) ester, or substituted or non-substituted (C₁-C₁₀) ketone; X and Y are independently CH₂, CH₂CH₂, oxygen or sulfur; and i is 0 or an integer of 1 to 2.

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U1S S1542 S3018

(56) Documents Cited

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(58) Field of Search

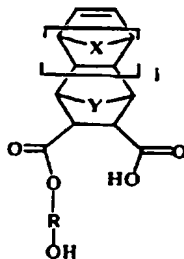
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(54) Abstract Title

Photoresist monomer having hydroxy group and carboxy group, copolymer thereof and photoresist composition using the same

(57) The present invention relates to novel monomers which can be used to form polymers which are useful in a photolithography employing a light source in the far ultraviolet region of the light spectrum, copolymers thereof, and photoresist compositions prepared therefrom. Photoresist monomers of the present invention are represented by the following Chemical Formula 1:

<Chemical Formula 1>



wherein,

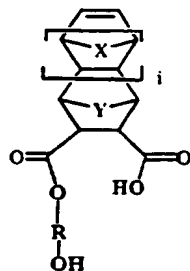
R is substituted or non-substituted linear or branched (C₁-C₁₀) alkyl, substituted or non-substituted (C₁-C₁₀) ether, substituted or non-substituted (C₁-C₁₀) ester, or substituted or non-substituted (C₁-C₁₀) ketone; X and Y are independently CH₂, CH₂CH₂, oxygen or sulfur; and i is 0 or an integer of 1 to 2.

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Still another object of the present invention is to provide a semiconductor element produced by using the photoresist composition.

The present invention provides a novel compound represented by following Chemical Formula 1:

<Chemical Formula 1>



wherein,

R is substituted or non-substituted linear or branched (C₁-C₁₀) alkyl, substituted or non-substituted (C₁-C₁₀) ether, substituted or non-substituted (C₁-C₁₀) ester, or substituted or non-substituted (C₁-C₁₀) ketone;

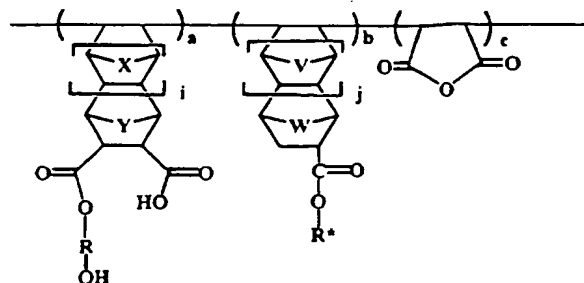
X and Y are independently CH₂, CH₂CH₂, oxygen or sulfur; and

i is 0 or an integer of 1 to 2.

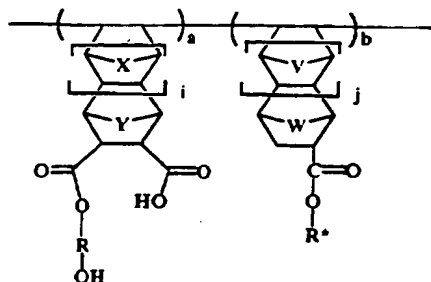
In order to achieve other technical objects, photoresist copolymer comprising repeating units of the monomer of Formula 1 are provided by another embodiment of the present invention.

Preferred copolymers are represented by following Chemical Formulas 100 and 100a:

<Chemical Formula 100>



<Chemical Formula 100a>



wherein,

R is substituted or non-substituted linear or branched (C₁-C₁₀) alkyl, substituted or non-substituted (C₁-C₁₀) ether, substituted or non-substituted (C₁-C₁₀) ester, or substituted or non-substituted (C₁-C₁₀) ketone;

X, Y, V and W are independently CH₂, CH₂CH₂, oxygen or sulfur;

i and j are independently 0 or an integer of 1 to 2;

R* is an acid-reactable group; and

a, b and c represent the polymerization ratio of the monomers.

In the case of the chemical formula 100, it is preferred that a : b : c = (0.01 – 0.2) : (0.1 – 0.4) : 0.5 in molar equivalent ratio.

The photoresist composition according to the present invention comprises (i) a photoresist copolymer according to the present invention, a photoacid generator and a conventional organic solvent.

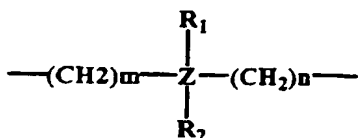
Hereinafter, the present invention will be described in detail.

Detailed Description of the Invention

Compounds of Chemical Formula 1 have been found to be particularly useful for preparing chemically amplified photoresist copolymers. Compounds of Chemical Formula 1 have a HYDROXY group which can enhance adhesiveness of the photoresist to a wafer substrate and a carboxylic acid group which can contribute to the enhancement of photo-sensitivity at the same time. In addition, the compounds can be simply synthesized without toxic odors and are readily crystallized in water without using any complicated separating means such as distillation or column chromatography. Thus, compounds of the present invention are advantageous in mass production at low cost.

In preferred compounds of Chemical Formula 1, R is represented by the following Chemical Formula 1a:

<Chemical Formula 1a>



wherein, Z is carbon or oxygen,;

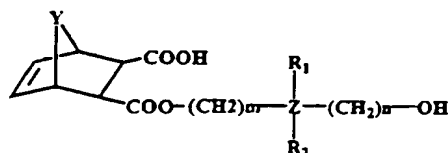
R₁ and R₂ are independently H or an (C₁-C₅) alkyl; and

m and n are independently 0 or an integer of 1 to 5.

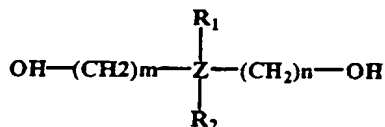
The photoresist monomer according to the present invention can be prepared by reacting (i) a di-alcohol such as ethylene glycol, 1,3-propanediol, 1,4-butanediol, 1,5-pentanediol, 2,2-diethyl-1,3-propanediol, 2,2-dimethyl-1,3-propanediol and diethylene glycol and (ii) an anhydride such as 5-norbornene-2,3-dicarboxylic anhydride and exo-3,6-epoxy-1,2,3,6-tetrahydrophthalic anhydride, in an organic solvent such as tetrahydrofuran, dimethylformamide, dioxane, benzene and toluene.

For example, the compound represented by the following Chemical Formula 2, one of the compounds represented by the above Formula 1, can be obtained by reacting a compound of Chemical Formulas 2a and 2b in the presence of an acid catalyst or a base:

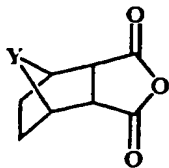
<Chemical Formula 2>



<Chemical Formula 2a>



<Chemical Formula 2b>



wherein, Y is CH₂, CH₂CH₂, oxygen or sulfur;

Z is carbon or oxygen;

R₁ and R₂ are independently H or an (C₁-C₅) alkyl; and

m and n are independently 0 or an integer of 1 to 5.

The compound of Chemical Formula 2a may be used in the same amount or in an excess

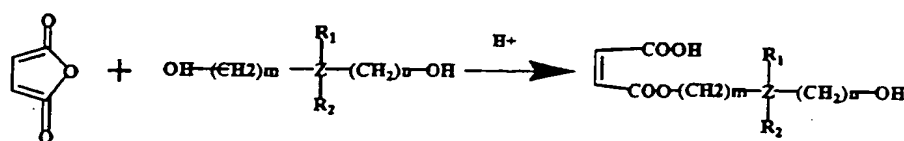
amount relative to the compound of Chemical Formula 2b.

NaH, KH, CaH₂, Na₂CO₃, LDA (lithium diisopropylamide) or the like may be used as a base, and sulfuric acid, acetic acid or nitric acid may be used as an acid catalyst.

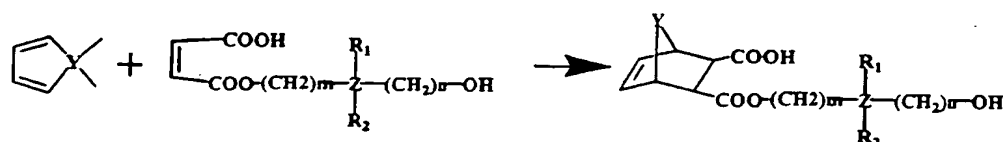
Novel monomers according to the present invention (the compounds represented by Chemical Formula 1) can also be prepared by a Diels-Alder reaction.

For example, the compound represented by the above chemical formula 2 can be prepared by following Reaction Schemes (1) and (2) below:

<Reaction Scheme 1>



<Reaction Scheme 2>



wherein,

Y is CH₂, CH₂CH₂, oxygen or sulfur;

Z is carbon or oxygen;

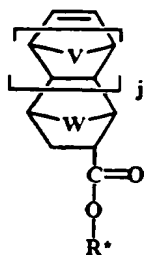
R₁ and R₂ are independently H or an (C₁-C₃) alkyl; and

m and n are independently 0 or an integer of 1 to 5.

That is, first, the intermediate material is obtained by reacting maleic anhydride and di-alcohol in an organic solvent such as benzene, tetrahydrofuran, dimethylformamide or dioxane in the presence of an acid catalyst, as shown in the Reaction Scheme 1, and then, the final product material is obtained by a Diels-Alder reaction which is performed in an organic solvent such as benzene and tetrahydrofuran, as shown in the Reaction Scheme 2.

Preferred photoresist copolymers according to the present invention comprise repeating units of a compound of Chemical Formula 1 as a first comonomer and a compound of the following Chemical Formula 3 as the second comonomer:

<Chemical Formula 3>



wherein,

V and W are independently CH_2 , CH_2CH_2 , oxygen or sulfur;

j is 0 or an integer of 1 to 2; and

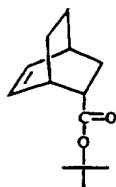
R* is an acid reactable group.

In the Chemical Formula 3, the R* is released when it is reacted with the acid produced by the photoacid generator in the photoresist composition. Thus, while the photoresist polymer in exposed regions of the photoresist layer becomes soluble in the developing solution, the polymer in the unexposed regions is not dissolved in the developing solution because acid is not generated therein and therefore the acid-reactable groups are still bound to the photoresist polymer. As the result, a predetermined pattern is formed.

Accordingly, the compounds of Chemical Formula 3 have a role in enhancing the photosensitivity of the photoresist polymer by increasing the difference in solubility in the developing solution between the exposed portion and the unexposed portion.

Suitable acid-reactable (acid labile) groups include tert-butyl, 2-tetrahydrofuranyl, 2-tetrahydropyranyl, 2-ethoxyethyl, t-butoxyethyl and so on. In a most preferred embodiment, the second comonomer is tert-butyl-5-norbornene-2-carboxylate, the compound of following Chemical Formula 3a:

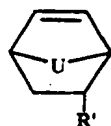
<Chemical Formula 3a>



Maleic anhydride or maleimide derivatives can be added as polymerization-enhancing monomers for making the polymerization between the cycloolefin compounds more efficient. However, when performing polymerization using a metal catalyst, such a polymerization-enhancing monomer is not necessarily required.

The first comonomer of Formula 1 and the second comonomer of Formula 3 comprising the photoresist copolymer according to the present invention each contain substituents having large steric hindrance. Therefore, in preferred copolymers a spacer comonomer, such as the compound of the following Chemical Formula 4, is added to the main polymer chain in order not only to reduce the steric hindrance (thus increasing the synthetic yield, preferably to over 40%), but also to properly adjust the molecular weight to a desirable range (preferably, in the range of 7,000 - 8,000).

<Chemical Formula 4>



wherein,

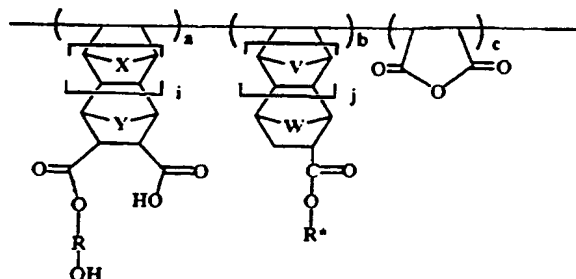
U is CH₂, CH₂CH₂, oxygen or sulfur; and

R' is hydrogen or C1-C5 alkyl.

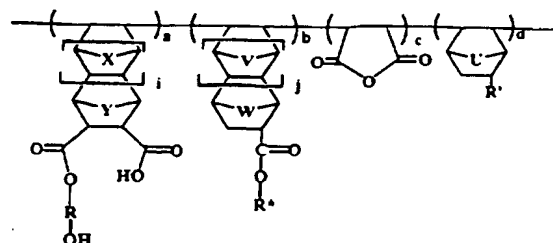
More preferred, the R' is hydrogen or methyl.

The following Chemical Formulas 100, 200, 100a and 200a represent preferred photoresist copolymers according to the present invention.

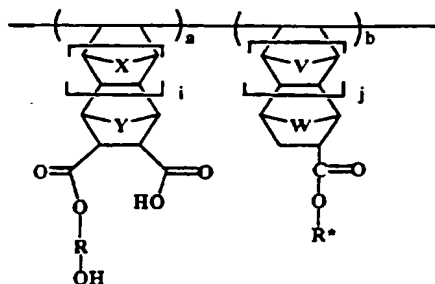
<Chemical Formula 100>



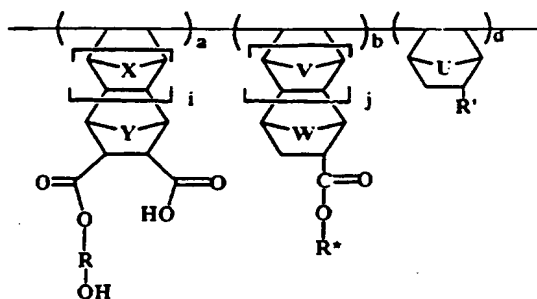
<Chemical Formula 200>



<Chemical Formula 100a>



<Chemical Formula 200a>



5

wherein,

X, Y, V, W and U are independently CH_2 , CH_2CH_2 , oxygen or sulfur;

R is substituted or non-substituted linear or branched (C_1 - C_{10}) alkyl, substituted or non-substituted (C_1 - C_{10}) ether, substituted or non-substituted (C_1 - C_{10}) ester, or substituted or non-substituted (C_1 - C_{10}) ketone;

10

R^* is an acid-reactable group;

R' is hydrogen or C_1 - C_5 alkyl;

i and j are independently 0 or an integer of 1 to 2; and

a, b, c and d are independently the polymerization ratio of the comonomers.

15

The molecular weight of the photoresist copolymers according to the present invention is 3,000 to 12,000, preferably, 5,000 to 10,000.

While the copolymers represented by the Chemical Formulas 100 and 200 are mainly obtained by a synthesizing method using a polymerization initiator, the copolymers represented by the Chemical Formulas 100a and 200a are mainly obtained by a synthesizing method using a metal catalyst.

20

A synthesizing method using a polymerization initiator is performed by reacting the comonomers in an organic solvent in the presence of a polymerization initiator. Presently preferred organic solvents include tetrahydrofuran, dimethylformamide, dimethyl sulfoxide, dioxane, methyl

ethyl ketone, benzene, toluene or xylene may be used. Conventional radical polymerization initiators, such as 2,2-azobisisobutyronitrile (AIBN), acetyl peroxide, lauryl peroxide and tert-butyl peroxide may be used in the synthesis of the copolymers of the present invention.

5 Photoresist compositions according to the present invention, which are useful for photolithography processes employing a deep ultraviolet light source such as ArF, may be prepared by dissolving a photoresist copolymer according to the present invention together with a conventional photoacid generator in a conventional organic solvent.

10 Sulfide or onium type compounds are preferably used as the photoacid generator. The photoacid generator may be one or more compounds selected from the group consisting of diphenyl iodide hexafluorophosphate, diphenyl iodide hexafluoroarsenate, diphenyliodide hexafluoroantimonate, diphenyl p-methoxyphenyl triflate, diphenyl p-toluenyl triflate, diphenyl p-isobutylphenyl triflate, diphenyl p-tert-butylphenyl triflate, triphenylsulfonium hexafluorophosphate, triphenylsulfonium hexafluoroarsenate, triphenylsulfonium hexafluoroantimonate, triphenylsulfonium triflate and dibutyl-naphthylsulfonium triflate. The
15 photoacid generator is used in an amount of 0.05 to 10 % by weight of the photoresist copolymer employed. If the amount of the photoacid generator is less than 0.05 % by weight, photosensitivity of the photoresist becomes poor. On the other hand, if the amount is more than 10%, the photoacid generator readily absorbs deep ultraviolet to provide a pattern having poor cross-sectional surface.

20 A conventional organic solvent, such as ethyl 3-ethoxypropionate, methyl 3-methoxypropionate, cyclohexanone, propylene glycol methyl ether acetate, or the like, may be used in the photoresist compositions of the present invention. The amount of solvent used is 200 to 1000% by weight of the photoresist copolymer, in order to obtain a photoresist layer of desirable thickness. According to the experiments by the present inventors, when the amount of solvent is 600 % by weight, a photoresist layer having a thickness of 0.5 μ m is obtained.

25 A conventional photoresist pattern-forming method can be used with the photoresist composition prepared according to the present invention, for example as follows:

30 First, the photoresist composition of the present invention is spin-coated on a silicon wafer to form a thin film, which is then soft-baked (i.e. heated in an oven or on a hot plate at 70 to 200°C, preferably at 80 to 150 °C for 1 to 5 minutes), and exposed to light by using an exposing device employing a deep ultraviolet light source, such as ArF light and KrF light, which has a wavelength below 250 nm. Then, the wafer is post-baked (i.e. heated at 70 to 200 °C, more preferably, 100 to 200 °C). Then, the wafer is impregnated in 2.38 % aqueous TMAH developing solution for 1.5

minutes, to obtain a photoresist image.

In the above procedure, the exposure energy is preferably 0.1 to 30 mJ/cm² and, instead of the deep ultraviolet light source, an E-beam, X-ray, EUV, VUV(Vacuum Ultra Violet) or similar light source may be used.

By employing the photoresist composition according to the present invention, a line/space (L/S) photoresist pattern having excellent adhesiveness and resolution is obtained, without pattern collapse, even when isolation is not more than 70 nm.

According to the present invention, a photoresist composition having excellent etching resistance and adhesiveness can be manufactured in large scale with low production cost, and a semiconductor element having excellent reliability can be prepared therefrom.

Detailed Description of Preferred Embodiments

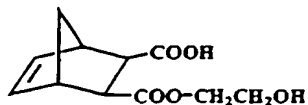
The invention is described in more detail by referring to the examples below, but it should be noted that the present invention is by no means restricted to such examples.

Synthesis of photoresist monomer

Example 1 : Synthesis of 5-norbornene-2-carboxylic acid-3-hydroxyethyl carboxylate

Ethylene glycol (0.1 mole) is added to 100 ml of tetrahydrofuran, and the mixture is chilled to -20 °C. The chilled mixture is stirred for 20 - 30 minutes in the presence of a basic catalyst, for example, 0.1 mole of sodium hydride. Then, 0.1 mole of 5-norbornene-2,3-dicarboxylic anhydride is slowly added thereto, and the temperature is raised to room temperature to perform the reaction for 24 hours. When the reaction is completed, tetrahydrofuran is distilled off, and the residue is mixed with 0.2 N hydrochloric acid solution (500 ml), and the mixture is crystallized in a refrigerator for several days. Then, the resultant material is filtered, washed with cold water (100 ml), and dried to obtain the compound of Chemical Formula 11 as a pure colorless solid (19.4 g / yield: 86%).

<Chemical Formula 11>



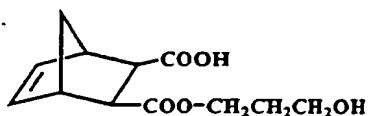
In the process described above, the crystallization step requires a long time (not less than a week). In order to solve the problem, the material resulting from the treatment with hydrochloric acid is extracted with 500 ml of ethyl acetate, dried over a dehydrating agent such as anhydrous magnesium sulfate and filtered. After evaporating the filtrate under reduced pressure, a white solid

is obtained, which is then recrystallized from acetone / petroleum ether to provide the compound of Chemical Formula 11 in a pure state (17.6 g / yield: 78%).

Example 2 : Synthesis of 5-norbornene-2-carboxylic acid-3-hydroxypropyl carboxylate

5 The procedure of Example 1 is repeated but using 1,3-propanediol instead of ethylene glycol as a reactant, to obtain the compound of Chemical Formula 12 as a colorless solid (21.1 g / yield: 88%).

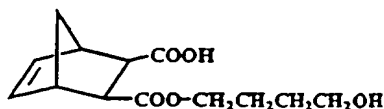
<Chemical Formula 12>



Example 3 : Synthesis of 5-norbornene-2-carboxylic acid-3-hydroxybutyl carboxylate

10 The procedure of Example 1 is repeated but using 1,3-butanediol instead of ethylene glycol as a reactant, to obtain the compound of Chemical Formula 13 as a colorless solid (22.6 g / yield: 89%).

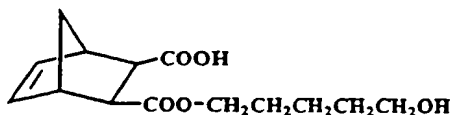
<Chemical Formula 13>



15 Example 4 : Synthesis of 5-norbornene-2-carboxylic acid-3-hydroxypentyl carboxylate

The procedure of Example 1 is repeated but using 1,5-pentanediol instead of ethylene glycol as a reactant, to obtain the compound of Chemical Formula 14 as a colorless solid (22.8 g / yield: 85%).

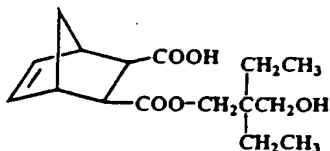
<Chemical Formula 14>



20 Example 5 : Synthesis of 5-norbornene-2-carboxylic acid-3-(2-ethyl-hydroxymethyl)butyl carboxylate

25 The procedure of Example 1 is repeated but using 2,2-diethyl-1,3-propanediol instead of ethylene glycol as a reactant, to obtain the compound of Chemical Formula 15 as a colorless solid (26.9 g / yield: 91%).

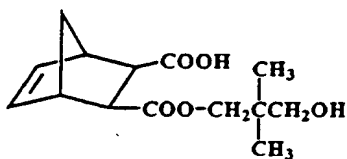
<Chemical Formula 15>



Example 6 : Synthesis of 5-norbornene-2-carboxylic acid-3-(2,2-dimethyl)hydroxypropyl carboxylate

5 The procedure of Example 1 is repeated but using 2,2-dimethyl-1,3-propanediol instead of ethylene glycol as a reactant, to obtain the compound of Chemical Formula 16 as a colorless solid (24.1 g / yield: 90%).

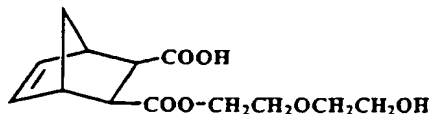
<Chemical Formula 16>



10 Example 7 : Synthesis of 5-norbornene-2-carboxylic acid-3-(2-hydroxyethoxy)ethyl carboxylate

The procedure of Example 1 is repeated but using diethylene glycol instead of ethylene glycol as a reactant, to obtain the compound of Chemical Formula 17 as a colorless solid (19.2 g / yield: 71%).

<Chemical Formula 17>

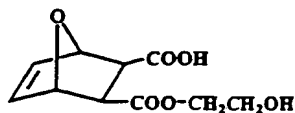


15 Example 8 : Synthesis of oxabicyclo[2.2.1]-hept-5-ene-2-carboxylic acid-3-hydroxyethyl carboxylate

20 Ethylene glycol (0.1 mole) is added to 100 ml of tetrahydrofuran, and the mixture is chilled to -20 °C. To the chilled mixture, sodium hydride (0.1 mole) is added, and the resultant mixture is stirred for 20 - 30 minutes. Then, 0.1 mole of exo-3,6-epoxy-1,2,3,6-tetrahydrophthalic anhydride is slowly added thereto, and the temperature is raised to room temperature to perform the reaction for 24 hours. When the reaction is completed, tetrahydrofuran is distilled off, and the residue is mixed with 0.2 N hydrochloric acid solution (500 ml), and the mixture is crystallized in a refrigerator for several days. Then, the resultant material is filtered, washed with cold water (100

ml), and dried to obtain the compound of Chemical Formula 18 as a colorless solid (19.4 g / yield: 86%).

<Chemical Formula 18>

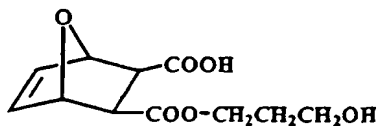


5 In the process for preparing the compound of Chemical Formula 18 described above, the crystallization step requires a long time of not less than a week. Thus, in order to solve the problem, the material resulting from the treatment with hydrochloric acid is extracted with 500 ml of ethyl acetate, dried over a dehydrating agent such as anhydrous magnesium sulfate, and filtered. After evaporating the filtrate under reduced pressure, a white solid is obtained, which is then
10 recrystallized from acetone / petroleum ether to provide the compound of Chemical Formula 18 in a pure state (17.6 g / yield: 78%).

Example 9 : Synthesis of oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-hydroxypropyl carboxylate

15 The procedure of Example 8 is repeated but using 1,3-propanediol instead of ethylene glycol as a reactant, to obtain the compound of Chemical Formula 19 as a colorless solid (20.8 g / yield: 86%).

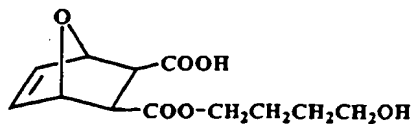
<Chemical Formula 19>



20 Example 10 : Synthesis of oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-hydroxybutyl carboxylate

The procedure of Example 8 is repeated but using 1,4-butanediol instead of ethylene glycol as a reactant, to obtain the compound of Chemical Formula 20 as a colorless solid (22.3 g / yield: 87%).

<Chemical Formula 20>



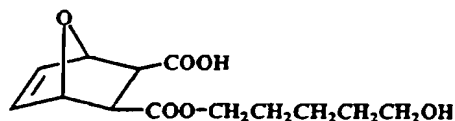
25 Example 11 : Synthesis of oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-hydroxypentyl carboxylate

carboxylate

The procedure of Example 8 is repeated but using 1,5-pentanediol instead of ethylene glycol as a reactant, to obtain the compound of Chemical Formula 21 as a colorless solid (23.8 g / yield: 88%).

5

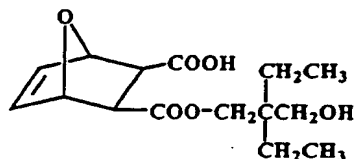
<Chemical Formula 21>



Example 12 : Synthesis of oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-(2-ethyl-2-hydroxymethyl)butyl carboxylate

10 The procedure of Example 8 is repeated but using 2,2-diethyl-1,3-propanediol instead of ethylene glycol as a reactant, to obtain the compound of Chemical Formula 22 as a colorless solid (27.7 g / yield: 93%).

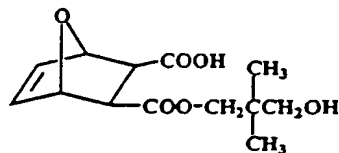
<Chemical Formula 22>



15 Example 13 : Synthesis of oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-(2,2-dimethyl)hydroxypropyl carboxylate

The procedure of Example 8 is repeated but using 2,2-dimethyl-1,3-propanediol instead of ethylene glycol as a reactant, to obtain the compound of Chemical Formula 23 as a colorless solid (23.6 g / yield: 86%).

<Chemical Formula 23>



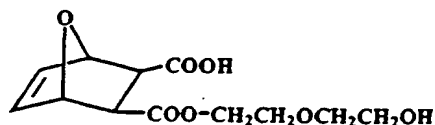
20

Example 14 : Synthesis of oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-(2-hydroxyethoxy)ethyl carboxylate

The procedure of Example 8 is repeated but using diethylene glycol instead of ethylene glycol as a reactant, to obtain the compound of Chemical Formula 24 as a colorless solid (21.2 g /

yield: 78%).

<Chemical Formula 24>



5

Synthesis of photoresist copolymer

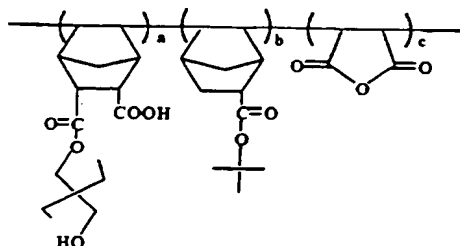
Example 15: Synthesis of poly(5-norbornene-2-carboxylic acid-3-(2,2-diethyl)-hydroxypropyl carboxylate / tert-butyl 5-norbornene-2-carboxylate / maleic anhydride)

5-norbornene-2-carboxylic acid-3-(2,2-diethyl)-hydroxypropyl carboxylate(0.2 mole), tert-butyl 5-norbornene-2-carboxylate(0.8 mole) and maleic anhydride (1.0 mole) are dissolved in tetrahydrofuran. Then, 0.5 to 10 g of AIBN (azobisisobutyronitrile) as a polymerization initiator is added thereto, and the resultant mixture is reacted at about 60-70 °C for 4 to 24 hours under nitrogen or argon atmosphere.

The polymer thus obtained is precipitated from ethyl ether or hexane, and dried to obtain the following compound of Chemical formula 101 (yield: 39%).

15

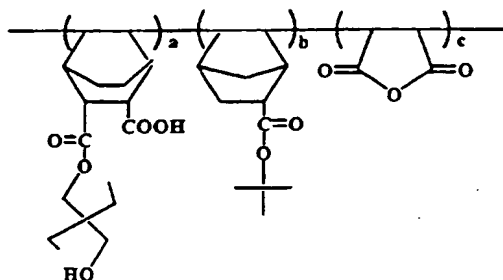
<Chemical Formula 101>



Example 16 : Synthesis of poly(mono-2-ethyl-2-hydroxymethylbutyl bicyclo[2.2.2]oct-5-ene-2,3-dicarboxylate / tert-butyl 5-norbornene-2-carboxylate / maleic anhydride)

The procedure of Example 15 is repeated but using mono-2-ethyl-2-hydroxymethylbutyl bicyclo[2.2.2]oct-5-ene-2,3-dicarboxylate (0.2 mole) instead of 5-norbornene-2-carboxylic acid-3-(2,2-diethyl)-hydroxypropyl carboxylate (0.2 mole), to obtain the compound represented by the following Chemical Formula 102. (yield: 36%).

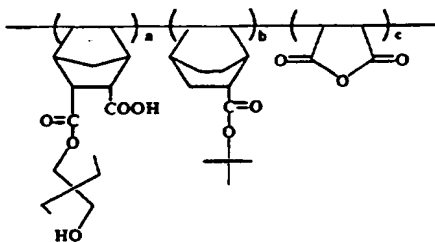
<Chemical Formula 102>



Example 17 : Synthesis of poly(5-norbornene-2-carboxylic acid-3-(2,2-diethyl)-hydroxypropyl carboxylate / tert-butyl bicyclo[2,2,2]oct-5-endo-2-carboxylate / maleic anhydride)

The procedure of Example 15 is repeated but using tert-butyl bicyclo[2,2,2]oct-5-endo-2-carboxylate (0.8 mole) instead of tert-butyl 5-norbornene-2-carboxylate (0.8 mole), to obtain the following compound represented by Chemical Formula 103. (yield: 38%).

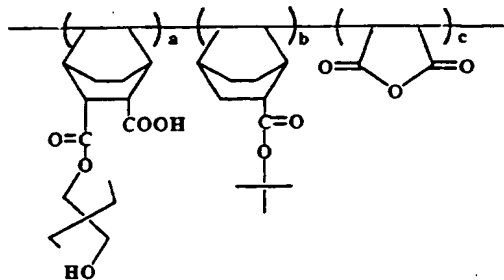
<Chemical Formula 103>



Example 18: Synthesis of poly(mono-2-ethyl-2-hydroxymethylbutyl bicyclo[2,2,2]oct-5-ene-2,3-dicarboxylate / tert-butyl bicyclo[2,2,2]oct-5-endo-2-carboxylate / maleic anhydride)

The procedure of Example 16 is repeated but using tert-butyl bicyclo[2,2,2]oct-5-endo-2-carboxylate (0.8 mole) instead of tert-butyl 5-norbornene-2-carboxylate (0.8 mole), to obtain the following compound represented by Chemical Formula 104. (yield: 42%).

<Chemical Formula 104>

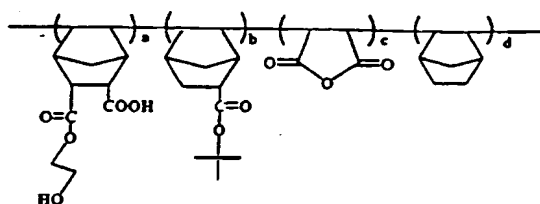


Example 19: Synthesis of poly(5-norbornene-2-carboxylic acid-3-hydroxyethyl

carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene)

In 25 ml of tetrahydrofuran, 5-norbornene-2-carboxylic acid-3-hydroxyethylcarboxylate (10 mmol), maleic anhydride (100 mmol), norbornene (20 mmol), tert-butyl-5-norbornene-2-carboxylate (70 mmol) and AIBN (0.30 g) are dissolved, and the solution is reacted at 65 °C for 10 hours. When the reaction is completed, the reaction mixture is poured into a solvent for crystallization, such as petroleum ether, to obtain a pure solid, which is then filtered off and dried to give the compound of Chemical Formula 105. (11.3 g / yield: 42%).

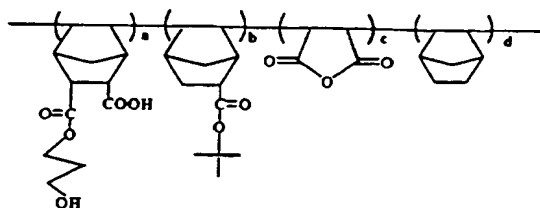
<Chemical Formula 105>



Example 20: Synthesis of poly(5-norbornene-2-carboxylic acid-3-hydroxypropyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene)

The procedure of Example 19 is repeated but using 5-norbornene-2-carboxylic acid-3-hydroxypropyl carboxylate as a reactant, instead of 5-norbornene-2-carboxylic acid-3-hydroxyethyl carboxylate, to obtain the compound represented by Chemical Formula 106 as a colorless solid (11.58 g / yield: 41%).

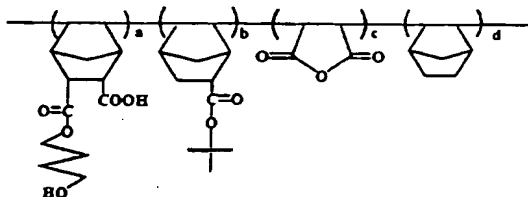
<Chemical Formula 106>



Example 21: Synthesis of poly(5-norbornene-2-carboxylic acid-3-hydroxybutyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene)

The procedure of Example 19 is repeated but using 5-norbornene-2-carboxylic acid-3-hydroxybutyl carboxylate as a reactant, instead of 5-norbornene-2-carboxylic acid-3-hydroxyethyl carboxylate to obtain the compound represented by Chemical Formula 107 as a colorless solid (11.36 g / yield: 40%).

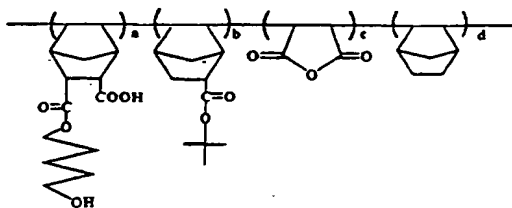
<Chemical Formula 107>



Example 22: Synthesis of poly(5-norbornene-2-carboxylic acid-3-hydroxypentyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene)

The procedure of Example 19 is repeated but using 5-norbornene-2-carboxylic acid-3-hydroxypentyl carboxylate as a reactant, instead of 5-norbornene-2-carboxylic acid-3-hydroxyethyl carboxylate to obtain the compound represented by following Chemical Formula 108 as a colorless solid (11.7 g / yield: 41%).

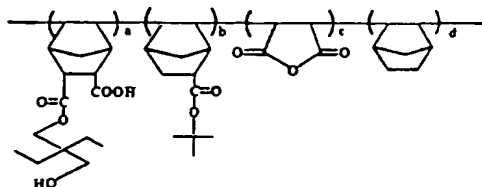
<Chemical Formula 108>



Example 23: Synthesis of poly(5-norbornene-2-carboxylic acid-3-(2-ethyl-2-hydroxymethyl)butyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene)

The procedure of Example 19 is repeated but using 5-norbornene-2-carboxylic acid-3-(2,2-diethyl)hydroxypropyl carboxylate as a reactant, instead of 5-norbornene-2-carboxylic acid-3-hydroxyethyl carboxylate to obtain the compound represented by following Chemical Formula 109 as a colorless solid (27.6 g / yield: 45%).

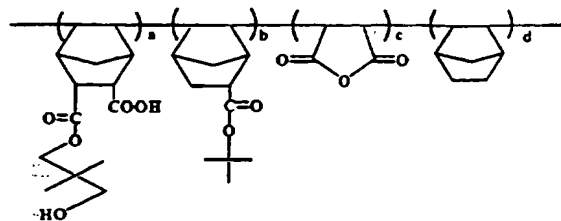
<Chemical Formula 109>



Example 24: Synthesis of poly(5-norbornene-2-carboxylic acid-3-(2,2-dimethyl)hydroxypropyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene)

The procedure of Example 19 is repeated but using 5-norbornene-2-carboxylic acid-3-(2,2,-dimethyl)hydroxypropyl carboxylate as a reactant, instead of 5-norbornene-2-carboxylic acid-3-hydroxyethyl carboxylate to obtain the compound represented by following Chemical Formula 110 as a colorless solid (11.7 g / yield: 43%).

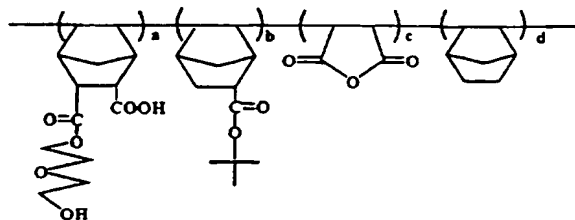
<Chemical Formula 110>



Example 25: Synthesis of poly(5-norbornene-2-carboxylic acid-3-(2-hydroxyethoxy)ethyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene)

The procedure of Example 19 is repeated but using 5-norbornene-2-carboxylic acid-3-(2-ethoxy)ethanol carboxylate as a reactant, instead of 5-norbornene-2-carboxylic acid-3-hydroxyethyl carboxylate to obtain the compound represented by following Chemical Formula 111 as a colorless solid (10.9 g / yield: 39%).

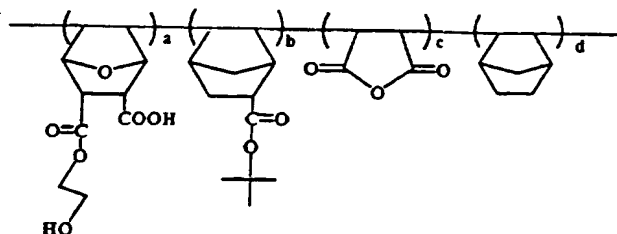
<Chemical Formula 111>



Example 26: Synthesis of poly(oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-hydroxyethyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene)

In 25 ml of tetrahydrofuran, oxabicyclo[2.2.1]oct-5-ene-2-carboxylic acid-3-hydroxyethyl carboxylate (10 mmol), maleic anhydride (100 mmol), norbornene (20 mmol), tert-butyl-5-norbornene-2-carboxylate (70 mmol) and AIBN (0.30 g) are dissolved, and the solution is reacted at 65 °C for 10 hours. After the reaction is completed, the reaction mixture is poured into diethyl ether to obtain a pure solid, which is then dried to give the compound represented by following Chemical Formula 112 (11 g / yield: 41%).

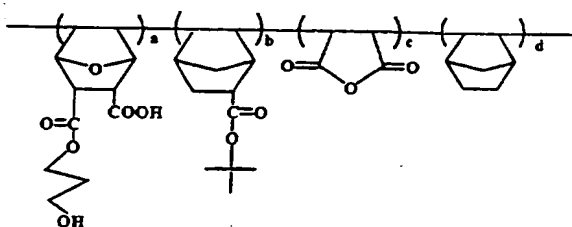
<Chemical Formula 112>



Example 27: Synthesis of poly(oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-hydroxypropyl carboxylate / maleic anhydride / norbornene / tert-butyl-5-norbornene-2-carboxylate)

The procedure of Example 26 is repeated but using oxabicyclo[2.2.1]oct-5-ene-2-carboxylic acid-3-hydroxypropyl carboxylate instead of oxabicyclo[2.2.1]oct-5-ene-2-carboxylic acid-3-hydroxyethyl carboxylate to obtain the compound represented by following Chemical Formula 113 as a colorless solid (11.3 g / yield: 42%).

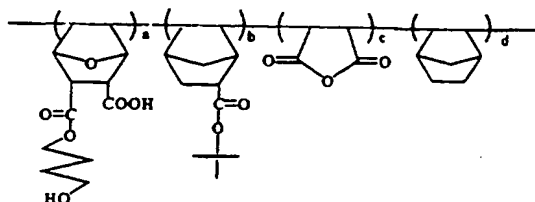
<Chemical Formula 113>



Example 28: Synthesis of poly(oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-hydroxybutyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene)

The procedure of Example 26 is repeated but using oxabicyclo[2.2.1]oct-5-ene-2-carboxylic acid-3-hydroxybutyl carboxylate instead of oxabicyclo[2.2.1]oct-5-ene-2-carboxylic acid-3-hydroxyethyl carboxylate to obtain the compound represented by following Chemical Formula 114 as a colorless solid (11.1 g / yield: 42%).

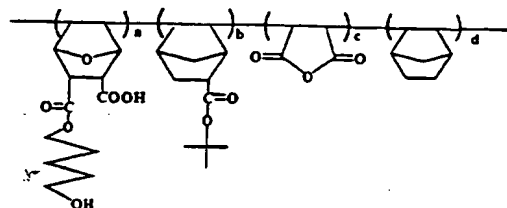
<Chemical Formula 114>



Example 29: Synthesis of poly(oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-hydroxypentyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene)

The procedure of Example 26 is repeated but using oxabicyclo[2.2.1]oct-5-ene-2-carboxylic acid-3-hydroxypropyl carboxylate as a reactant, instead of oxabicyclo[2.2.1]oct-5-ene-2-carboxylic acid-3-hydroxyethyl carboxylate to obtain the compound represented by following Chemical Formula 115 as a colorless solid (10.9 g / yield: 40%).

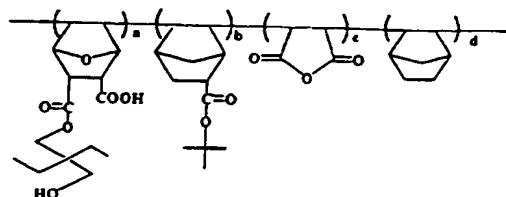
<Chemical Formula 115>



Example 30: Synthesis of poly(oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-(2,2-diethyl)hydroxypropyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene)

The procedure of Example 26 is repeated but using oxabicyclo[2.2.1]oct-5-ene-2-carboxylic acid-3-(2,2-diethyl)hydroxypropyl carboxylate as a reactant, instead of oxabicyclo[2.2.1]oct-5-ene-2-carboxylic acid-3-hydroxyethyl carboxylate to obtain the compound represented by following Chemical Formula 116 as a colorless solid (12.1 g / yield: 44%).

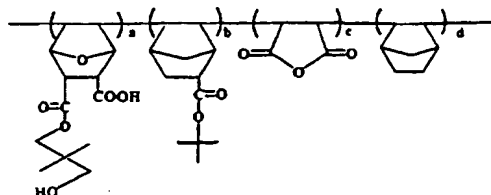
<Chemical Formula 116>



Example 31: Synthesis of poly(oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-(2,2-dimethyl)hydroxypropyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene)

The procedure of Example 26 is repeated but using oxabicyclo[2.2.1]oct-5-ene-2-carboxylic acid-3-(2,2-dimethyl)hydroxypropyl carboxylate as a reactant, instead of oxabicyclo[2.2.1]oct-5-ene-2-carboxylic acid-3-hydroxyethyl carboxylate to obtain the compound represented by following Chemical Formula 117 as a colorless solid (11.7 g / yield: 43%).

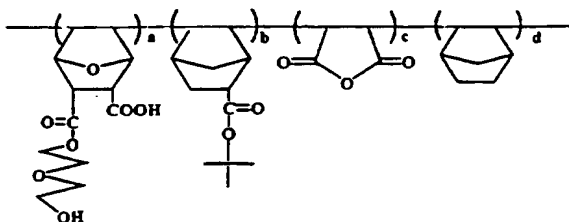
<Chemical Formula 117>



Example 32: Synthesis of poly(oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-(2-ethoxy)ethanol carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene)

The procedure of Example 26 is repeated but using oxabicyclo[2.2.1]oct-5-ene-2-carboxylic acid-3-(2-ethoxy)ethanol carboxylate as a reactant, instead of oxabicyclo[2.2.1]oct-5-ene-2-carboxylic acid-3-hydroxyethyl carboxylate to obtain the compound represented by following Chemical Formula 118 as a colorless solid (10.7 g / yield: 39%).

<Chemical Formula 118>



In the Examples described above, petroleum ether or diethyl ether is employed as a solvent for crystallization. Alternatively, alcohols such as methanol, ethanol and isopropanol may be employed.

Preparation of photoresist composition and formation of photoresist pattern

Example 33

10g of poly(5-norbornene-2-carboxylic acid-3-(2,2-diethyl)-hydroxypropyl carboxylate / tert-butyl 5-norbornene-2-carboxylate / maleic anhydride) obtained from the Example 15 is dissolved in 40 g of 3-methoxymethyl propionate, and triphenylsulfonium triflate or dibutyl naphthyl sulfonium triflate(0.01 – 1 g) is added thereto as a photoacid generator. After stirring, the resultant mixture is filtered through a 0.10 μm filter to obtain a photoresist composition. The photoresist composition thus obtained is coated in about 0.3 μm thickness on a surface, and exposed to light by using 193 nm of ArF light source. Then the photoresist is post-baked, and the semiconductor element is impregnated in 2.38% aqueous tetramethylammonium hydroxide

(TMAH) solution to be developed and thus 0.13 μ m L/S pattern is obtained.

Example 34

The procedure of Example 33 is repeated but using the photoresist copolymer obtained from the Example 16 instead of that obtained from the Example 15 and thus a 0.13 μ m L/S pattern is obtained.

Example 35

The copolymer obtained from Example 19 (10 g) and triphenylsulfonium triflate (0.12 g) as a photoacid generator are dissolved in ethyl 3-ethoxypropionate solvent (60 g), and the resultant mixture is filtered through a 0.10 μ m filter to prepare a photoresist solution. The photoresist solution thus prepared is spin-coated on a silicon wafer, and soft-baked at 110 °C for 90 seconds. After baking, the wafer is irradiated with light exposure energy of 0.1 to 10 mJ/cm² by using an ArF laser exposer, and the wafer is post-baked again at 110 °C for 90 seconds. When the post-baking is completed, it is developed in 2.38 wt% aqueous TMAH (tetramethylammonium hydroxide) solution for 40 seconds, to obtain a 0.11 μ m L/S pattern.

Example 36

The procedure according to Example 35 is repeated but using the same amount of the copolymer obtained from Example 20 instead of the copolymer of Example 19, to obtain 0.13 μ m L/S pattern.

Example 37

The procedure according to Example 35 is repeated but using the same amount of the copolymer obtained from Example 21 instead of the copolymer of Example 19, to obtain a 0.13 μ m L/S pattern.

Example 38

The procedure according to Example 35 is repeated but using the same amount of the copolymer obtained from Example 22 instead of the copolymer of Example 19, to obtain a 0.13 μ m L/S pattern.

Example 39

The procedure according to Example 35 is repeated but using the same amount of the copolymer obtained from Example 23 instead of the copolymer of Example 19, to obtain a 0.13 μ m

L/S pattern.

Example 40

The procedure according to Example 35 is repeated but using the same amount of the copolymer obtained from Example 24 instead of the copolymer of Example 19, to obtain a 0.13 μ m L/S pattern.

Example 41

The procedure according to Example 35 is repeated but using the same amount of the copolymer obtained from Example 25 instead of the copolymer of Example 19, to obtain a 0.12 μ m L/S pattern.

Example 42

The procedure according to Example 35 is repeated but using the same amount of the copolymer obtained from Example 26 instead of the copolymer of Example 19, to obtain a 0.12 μ m L/S pattern.

Example 43

The procedure according to Example 35 is repeated but using the same amount of the copolymer obtained from Example 27 instead of the copolymer of Example 19, to obtain a 0.11 μ m L/S pattern.

Example 44

The procedure according to Example 35 is repeated but using the same amount of the copolymer obtained from Example 28 instead of the copolymer of Example 19, to obtain a 0.13 μ m L/S pattern.

Example 45

The procedure according to Example 35 is repeated but using the same amount of the copolymer obtained from Example 29 instead of the copolymer of Example 19, to obtain a 0.13 μ m L/S pattern.

Example 46

The procedure according to Example 35 is repeated but using the same amount of the copolymer obtained from Example 30 instead of the copolymer of Example 19, to obtain a 0.12 μ m L/S pattern.

Example 47

The procedure according to Example 35 is repeated but using the same amount of the copolymer obtained from Example 31 instead of the copolymer of Example 19, to obtain a 0.13 μ m L/S pattern.

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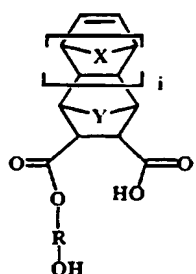
Example 48

The procedure according to Example 35 is repeated but using the same amount of the copolymer obtained from Example 32 instead of the copolymer of Example 19, to obtain a 0.13 μ m L/S pattern.

What is claimed is:

1. A photoresist monomer represented by following Chemical formula 1:

<Chemical Formula 1>



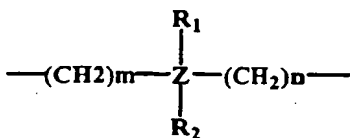
wherein,

R is substituted or non-substituted linear or branched (C₁-C₁₀) alkyl, substituted or non-substituted (C₁-C₁₀) ether, substituted or non-substituted (C₁-C₁₀) ester, or substituted or non-substituted (C₁-C₁₀) ketone;

X and Y are independently CH₂, CH₂CH₂, oxygen or sulfur; and
i is 0 or an integer of 1 to 2.

2. A photoresist monomer according to claim 1, wherein said R is represented by the following Chemical Formula 1a.

<Chemical Formula 1a>



wherein, Z is carbon or oxygen,;

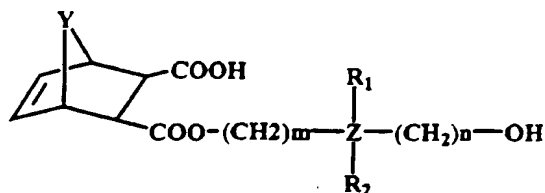
R₁ and R₂ are independently H or an (C₁-C₅) alkyl; and

m and n are independently 0 or an integer of 1 to 5.

3. A photoresist monomer according to claim 1, wherein said i is zero.

4. A photoresist monomer according to claim 1, wherein said photoresist monomer is represented by the following Chemical Formula 2.

<Chemical Formula 2>



wherein, Y is CH₂, CH₂CH₂, oxygen or sulfur;

Z is carbon or oxygen;

R₁ and R₂ are independently H or an (C₁-C₅) alkyl; and

m and n are independently 0 or an integer of 1 to 5.

5. A photoresist monomer according to claim 1, wherein said photoresist monomer is selected from the group consisting of

5-norbornene-2-carboxylic acid-3-hydroxyethyl carboxylate;

5-norbornene-2-carboxylic acid-3-hydroxypropyl carboxylate;

5-norbornene-2-carboxylic acid-3-hydroxybutyl carboxylate;

5-norbornene-2-carboxylic acid-3-hydroxypentyl carboxylate;

5-norbornene-2-carboxylic acid-3-(2-ethyl-hydroxymethyl)butyl carboxylate;

5-norbornene-2-carboxylic acid-3-(2,2-dimethyl)hydroxypropyl carboxylate;

5-norbornene-2-carboxylic acid-3-(2-hydroxyethoxy)ethyl carboxylate;

oxabicyclo[2.2.1]-hept-5-ene-2-carboxylic acid-3-hydroxyethyl carboxylate;

oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-hydroxypropyl carboxylate;

oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-hydroxybutyl carboxylate;

oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-hydroxypentyl carboxylate;

oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-(2-ethyl-2-hydroxymethyl)butyl carboxylate;

oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-(2,2-dimethyl)hydroxypropyl carboxylate; and

oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-(2-hydroxyethoxy)ethyl carboxylate.

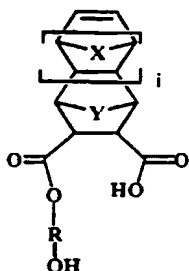
6. A method for synthesizing a photoresist monomer represented by the following Chemical Formula 1 comprising;

(a) dissolving a di-alcohol compound in an organic solvent;

(b) adding an acid catalyst or a base to the resultant solution with stirring; and

(c) adding an anhydride compound to the resultant solution to obtain a compound of Formula 1:

<Chemical Formula 1>



wherein,

R is substituted or non-substituted linear or branched (C₁-C₁₀) alkyl, substituted or non-substituted (C₁-C₁₀) ether, substituted or non-substituted (C₁-C₁₀) ester, or substituted or non-substituted (C₁-C₁₀) ketone;

X and Y are independently CH₂, CH₂CH₂, oxygen or sulfur; and

i is 0 or an integer of 1 to 2.

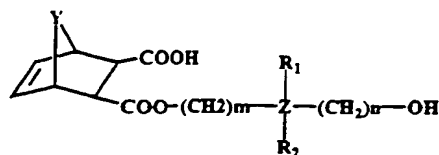
7. A method according to the claim 6, wherein said anhydride compound is 5-norbornene-2,3-dicarboxylic anhydride or exo-3,6-epoxy-1,2,3,6-tetrahydrophthalic anhydride.
8. A method according to the claim 6, wherein said di-alcohol compound is selected from the group consisting of ethylene glycol, 1,3-propanediol, 1,4-butanediol, 1,5-pentanediol, 2,2-diethyl-1,3-propanediol, 2,2-dimethyl-1,3-propanediol and diethylene glycol.
9. A method according to the claim 6, wherein said organic solvent is selected from the group consisting of tetrahydrofuran, dimethylformamide, dioxane, benzene and toluene.
10. A method according to the claim 6, wherein said base is selected from the group consisting of NaH, KH, CaH₂, Na₂CO₃ and LDA (lithium diisopropylamide).
11. A method according to the claim 6, wherein said acid is selected from the group consisting of sulfuric acid, acetic acid and nitric acid.
12. A method for synthesizing the photoresist monomer represented by Chemical Formula 2

below, comprising;

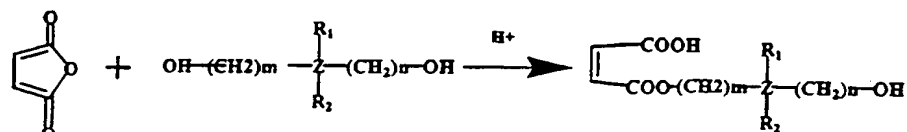
(a) reacting a maleic anhydride and a di-alcohol compound in the presence of an acid catalyst, as shown in Reaction Scheme 1 below; and

(b) performing a Diels-Alder reaction with the resultant product, as shown in Reaction Scheme 2 below:

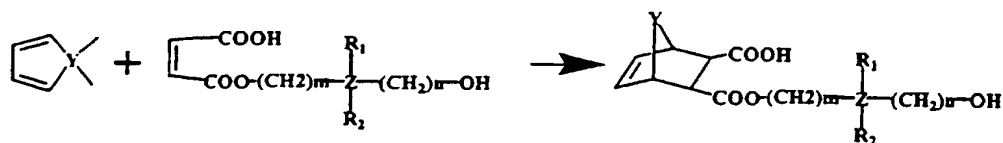
<Chemical Formula 2>



<Reaction Scheme 1>



<Reaction Scheme 2>



wherein,

Y is CH₂, CH₂CH₂, oxygen or sulfur;

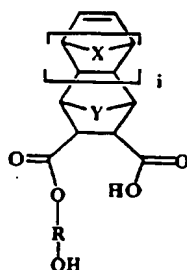
Z is carbon or oxygen;

R₁ and R₂ are independently H or an (C₁-C₅) alkyl; and

m and n are independently 0 or an integer of 1 to 5.

13. A photoresist polymer comprising at least one monomer represented by the Chemical Formula 1 below:

<Chemical Formula 1>



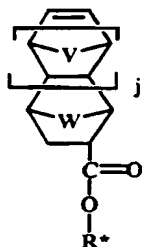
wherein,

R is substituted or non-substituted linear or branched (C₁-C₁₀) alkyl, substituted or non-substituted (C₁-C₁₀) ether, substituted or non-substituted (C₁-C₁₀) ester, or substituted or non-substituted (C₁-C₁₀) ketone;

- 5 X and Y are independently CH₂, CH₂CH₂, oxygen or sulfur; and
i is 0 or an integer of 1 to 2.

14. A photoresist polymer according to Claim 13 further comprising a second comonomer represented by the Chemical Formula 3:

<Chemical Formula 3>



wherein,

V and W are independently CH₂, CH₂CH₂, oxygen or sulfur;

R* is an acid-reactable group; and

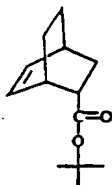
j is 0 or an integer of 1 to 2.

- 15 15. A photoresist copolymer according to the claim 14, wherein said R* is tert-butyl, 2-tetrahydrofuranyl, 2-tetrahydropyranyl, 2-ethoxyethyl or t-butoxyethyl.

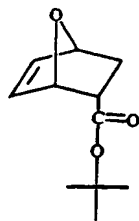
16. A photoresist copolymer according to the claim 14, wherein said i = j = 0.

- 20 17. A photoresist copolymer according to the claim 14, wherein said compound represented by the following Chemical Formula 3 is tert-butyl-5-norbornene-2-carboxylate, the compound of following Chemical Formula 3a or the compound of following Chemical Formula 3b:

<Chemical Formula 3a>



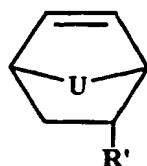
<Chemical Formula 3b>



18. A photoresist copolymer according to the claim 14 further comprising a polymerization-enhancing monomer selected from the group consisting of maleic anhydride and maleimide derivatives.

19. A photoresist copolymer according to the claim 14, said photoresist copolymer further comprising a spacer material represented by the following Chemical Formula 4.

<Chemical Formula 4>



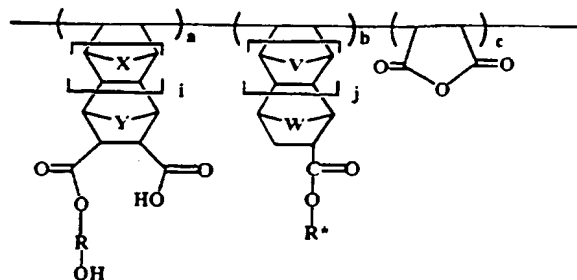
wherein,

U is CH₂, CH₂CH₂, oxygen or sulfur; and

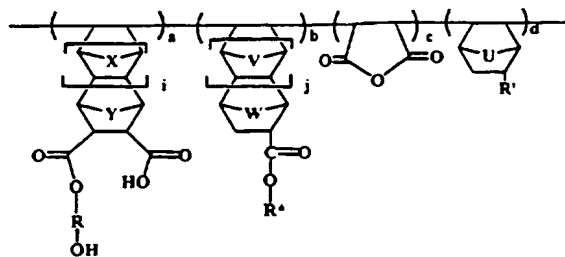
R' is hydrogen or C1-C5 alkyl.

20. A photoresist copolymer according to the claim 14, wherein said photoresist copolymer is selected from the group consisting of the following Chemical Formulas 100, 200, 100a and 200a.

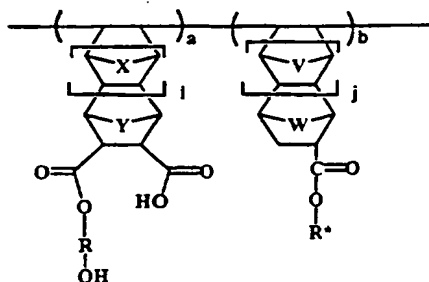
<Chemical Formula 100>



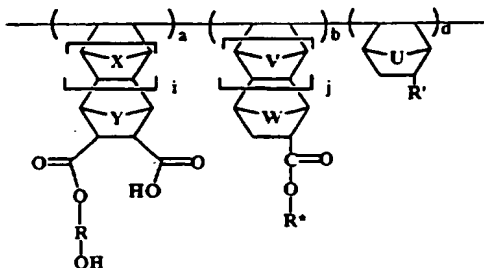
<Chemical Formula 200>



<Chemical Formula 100a>



<Chemical Formula 200a>



5

wherein,

X, Y, V, W and U are independently CH₂, CH₂CH₂, oxygen or sulfur;

R is substituted or non-substituted linear or branched (C₁-C₁₀) alkyl, substituted or non-substituted (C₁-C₁₀) ether, substituted or non-substituted (C₁-C₁₀) ester, or substituted or non-substituted (C₁-C₁₀) ketone;

10

R* is an acid-reactable group;

R' is hydrogen or C₁-C₅ alkyl;

i and j are independently 0 or an integer of 1 to 2; and

a, b, c and d are independently the polymerization ratios of the monomers.

15

21. A photoresist copolymer according to the claim 14 wherein the average molecular weight of said photoresist copolymer is 3,000 to 12,000.

22. A photoresist copolymer according to the claim 14, wherein said photoresist copolymer is selected from the group consisting of

poly(5-norbornene-2-carboxylic acid-3-(2,2-diethyl)-hydroxypropyl carboxylate / tert-butyl 5-norbornene-2-carboxylate / maleic anhydride);

5 poly(mono-2-ethyl-2-hydroxymethylbutyl bicyclo[2,2,2]oct-5-ene-2,3-dicarboxylate / tert-butyl 5-norbornene-2-carboxylate / maleic anhydride);

poly(5-norbornene-2-carboxylic acid-3-(2,2-diethyl)-hydroxypropyl carboxylate / tert-butyl bicyclo[2,2,2]oct-5-endo-2-carboxylate / maleic anhydride);

10 poly(mono-2-ethyl-2-hydroxymethylbutyl bicyclo[2,2,2]oct-5-ene-2,3-dicarboxylate / tert-butyl bicyclo[2,2,2]oct-5-endo-2-carboxylate / maleic anhydride);

poly(5-norbornene-2-carboxylic acid-3-hydroxyethyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene);

poly(5-norbornene-2-carboxylic acid-3-hydroxypropyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene);

15 poly(5-norbornene-2-carboxylic acid-3-hydroxybutyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene);

poly(5-norbornene-2-carboxylic acid-3-hydroxypentyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene);

20 poly(5-norbornene-2-carboxylic acid-3-(2-ethyl-2-hydroxymethyl)butyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene);

poly(5-norbornene-2-carboxylic acid-3-(2,2-dimethyl)hydroxypropyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene);

poly(5-norbornene-2-carboxylic acid-3-(2-hydroxyethoxy)ethyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene);

25 poly(oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-hydroxyethyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene);

poly(oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-hydroxypropyl carboxylate / maleic anhydride / norbornene / tert-butyl-5-norbornene-2-carboxylate);

30 poly(oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-hydroxybutyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene);

poly(oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-hydroxypropyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene);

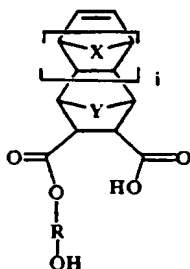
poly(oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-(2,2-diethyl)hydroxypropyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene);

5 poly(oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-(2,2-dimethyl)hydroxypropyl carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene); and

poly(oxabicyclo[2.2.1]hept-5-ene-2-carboxylic acid-3-(2-ethoxy)ethanol carboxylate / tert-butyl-5-norbornene-2-carboxylate/ maleic anhydride / norbornene).

- 10 23. A method for synthesizing a photoresist copolymer, which comprising
- (a) dissolving in an organic solvent (i) a compound represented by the following Chemical Formula 1, (ii) a compound represented by the following Chemical Formula 3 and (iii) at least one of maleic anhydride and maleimide derivatives; and
- 15 (b) adding a polymerization initiator to the resultant solution to induce a polymerization reaction.

<Chemical Formula 1>



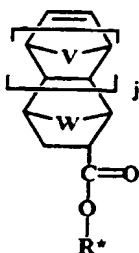
wherein,

20 R is substituted or non-substituted linear or branched (C₁-C₁₀) alkyl, substituted or non-substituted (C₁-C₁₀) ether, substituted or non-substituted (C₁-C₁₀) ester, or substituted or non-substituted (C₁-C₁₀) ketone;

X and Y are independently CH₂, CH₂CH₂, oxygen or sulfur; and

i is 0 or an integer of 1 to 2.

25 <Chemical Formula 3>



wherein,

V and W are independently CH_2 , CH_2CH_2 , oxygen or sulfur;

R^* is an acid-reactable group; and

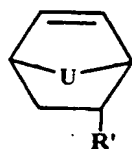
j is 0 or an integer of 1 to 2.

24. A method according to the claim 23 wherein said organic solvent is selected from the group consisting of tetrahydrofuran, dimethylformamide, dimethyl sulfoxide, dioxane, methyl ethyl ketone, benzene, toluene and xylene.

25. A method according to the claim 23, wherein said polymerization initiator is selected from the group consisting of 2,2-azobisisobutyronitrile (AIBN), acetyl peroxide, lauryl peroxide and tert-butyl peroxide.

26. A method according to the claim 23, wherein said (a) step further comprises adding a spacer monomer represented by the following Chemical Formula 4 into the organic solvent.

<Chemical Formula 4>



wherein,

U is CH_2 , CH_2CH_2 , oxygen or sulfur; and

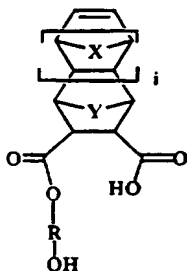
R' is hydrogen or $\text{C}_1\text{-C}_5$ alkyl.

27. A method of synthesizing a photoresist copolymer, which comprises:

(a) dissolving in an organic solvent (i) a compound represented by the following Chemical Formula 1 and (ii) a compound represented by the following Chemical Formula 3, and

(b) adding a metal catalyst to the resultant solution to induce polymerization reaction.

<Chemical Formula 1>



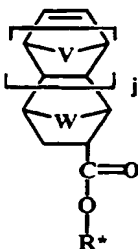
wherein,

R is substituted or non-substituted linear or branched (C₁-C₁₀) alkyl, substituted or non-substituted (C₁-C₁₀) ether, substituted or non-substituted (C₁-C₁₀) ester, or substituted or non-substituted (C₁-C₁₀) ketone;

X and Y are independently CH₂, CH₂CH₂, oxygen or sulfur; and

i is 0 or an integer of 1 to 2.

<Chemical Formula 3>



wherein,

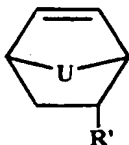
V and W are independently CH₂, CH₂CH₂, oxygen or sulfur;

R* is an acid-reactable group; and

j is 0 or an integer of 1 to 2.

28. A method according to the claim 27, wherein said (a) step further comprises the step of adding a spacer monomer represented by the following Chemical Formula 4 to the organic solvent.

<Chemical Formula 4>



wherein,

U is CH₂, CH₂CH₂, oxygen or sulfur; and

R' is hydrogen or C1-C5 alkyl.

5 29. A photoresist composition comprising (i) a photoresist copolymer of claims 13, 14, 18 or 19; (ii) a photoacid generator and (iii) an organic solvent.

30. A photoresist composition according to claim 29, wherein said photoacid generator is sulfide or onium type compounds.

10

31. A photoresist composition according to claim 29, wherein said photoacid generator is selected from the group consisting of diphenyl iodide hexafluorophosphate, diphenyl iodide hexafluoroarsenate, diphenyliodide hexafluoroantimonate, diphenyl p-methoxyphenyl triflate, diphenyl p-toluenyl triflate, diphenyl p-isobutylphenyl triflate, diphenyl p-tert-butylphenyl triflate, triphenylsulfonium
15 hexafluorophosphate, triphenylsulfonium hexafluoroarsenate, triphenylsulfonium hexafluoroantimonate, triphenylsulfonium triflate and dibutyl-naphthylsulfonium triflate.

32. A photoresist composition according to claim 29, wherein said organic solvent is selected from the group consisting of ethyl 3-ethoxypropionate, methyl 3-methoxypropionate, cyclohexanone and
20 propyleneglycol methylether acetate.

33. A process for forming a photoresist pattern, said process comprising
(a) coating a photoresist composition of claim 29 on a semiconductor substrate to
form a photoresist film;
25 (b) exposing the photoresist film using an exposing device; and
(c) developing the photoresist film.

34. A process according to claim 32, which further comprises a step of soft-baking after step (a).

30 35. A process according to claim 34, wherein the soft-baking is performed at 70 - 200°C.

36. A process according to claim 33 which further comprises a step of post-baking, after step (b).

37. A process according to claim 36, wherein the post-baking is performed at 70 - 200 °C.
38. A process according to claim 33, wherein said exposing device employs a light source having a wavelength below 250 nm.
- 5 39. A process according to claim 33, wherein said exposing device employs a light source selected from the group consisting of ArF, KrF, E-beam, ion-beam, VUV(Vacuum Ultra Violet), EUV and X-ray.
- 10 40. A semiconductor element manufactured by the process of the claim 33.



Application No: GB 9920124.6
Claims searched: 1-40

Examiner: Dr William Thomson
Date of search: 17 November 1999

Patents Act 1977
Search Report under Section 17

Databases searched:

UK Patent Office collections, including GB, EP, WO & US patent specifications, in:
UK Cl (Ed.Q): C2C (CBC, CBM)
Int Cl (Ed.6):
Other: ONLINE: CAS-ONLINE

Documents considered to be relevant:

Category	Identity of document and relevant passage	Relevant to claims
	NONE	

X	Document indicating lack of novelty or inventive step	A	Document indicating technological background and/or state of the art.
Y	Document indicating lack of inventive step if combined with one or more other documents of same category.	P	Document published on or after the declared priority date but before the filing date of this invention.
&	Member of the same patent family	E	Patent document published on or after, but with priority date earlier than, the filing date of this application.